

Complementary Silicon Power Plastic Transistors

... designed for low power audio amplifier and low-current, high-speed switching applications.

• High Collector–Emitter Sustaining Voltage —

VCEO(sus) = 100 Vdc (Min) — MJE243, MJE253

• High DC Current Gain @ I_C = 200 mAdc

h_{FE} = 40–200 = 40–120 — MJE243, MJE253

• Low Collector-Emitter Saturation Voltage —

 $V_{CE(sat)} = 0.3 \text{ Vdc (Max)} @ I_C = 500 \text{ mAdc}$

• High Current Gain Bandwidth Product —

 $f_T = 40 \text{ MHz (Min)} @ I_C = 100 \text{ mAdc}$

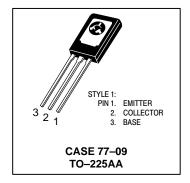
• Annular Construction for Low Leakages

I_{CBO} = 100 nAdc (Max) @ Rated V_{CB}

NPN MJE243* PNP MJE253*

*ON Semiconductor Preferred Device

4 AMPERE
POWER TRANSISTORS
COMPLEMENTARY
SILICON
100 VOLTS
15 WATTS



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	VCEO	100	Vdc
Collector–Base Voltage	V _{CB} 100		Vdc
Emitter-Base Voltage	V _{EB}	7.0	Vdc
Collector Current — Continuous Peak	lc	4.0 8.0	Adc
Base Current	ΙB	10	Adc
Total Power Dissipation @ T _C = 25°C Derate above 25°C	PD	15 0.12	Watts W/ac
Total Power Dissipation @ T _A = 25°C Derate @ 25°C	PD	1.5 0.012	Watts W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	θЈС	8.34	°C/W
Thermal Resistance, Junction to Ambient	θЈА	83.4	°C/W

Preferred devices are ON Semiconductor recommended choices for future use and best overall value.

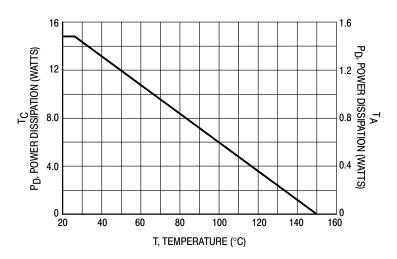
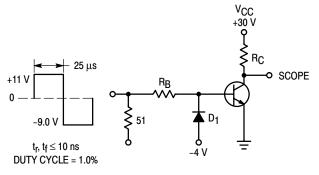


Figure 1. Power Derating

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS	1			1
Collector–Emitter Sustaining Voltage (I _C = 10 mAdc, I _B = 0)	VCEO(sus)	100	_	Vdc
Collector Cutoff Current ($V_{CB} = 100 \text{ Vdc}$, $I_{E} = 0$) ($V_{CE} = 100 \text{ Vdc}$, $I_{E} = 0$, $T_{C} = 125^{\circ}\text{C}$)	ІСВО		0.1 0.1	μAdc
Emitter Cutoff Current ($V_{BE} = 7.0 \text{ Vdc}$, $I_{C} = 0$)	I _{EBO}		0.1	μAdc
ON CHARACTERISTICS	·			•
DC Current Gain ($I_C = 200 \text{ mAdc}$, $V_{CE} = 1.0 \text{ Vdc}$) ($I_C = 1.0 \text{ Adc}$, $V_{CE} = 1.0 \text{ Vdc}$)	hFE	40 15	180 —	_
Collector–Emitter Saturation Voltage (I _C = 500 mAdc, I _B = 50 mAdc) (I _C = 1.0 Adc, I _B = 100 mAdc)	VCE(sat)		0.3 0.6	Vdc
Base–Emitter Saturation Voltage (I _C = 2.0 Adc, I _B = 200 mAdc)	VBE(sat)	_	1.8	Vdc
Base–Emitter On Voltage (I _C = 500 mAdc, V _{CE} = 1.0 Vdc)	V _{BE} (on)	_	1.5	Vdc
DYNAMIC CHARACTERISTICS				
Current–Gain — Bandwidth Product (I _C = 100 mAdc, V _{CE} = 10 Vdc, f _{test} = 10 MHz)	fΤ	40	_	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 0.1 MHz)	C _{ob}	_	50	pF



 R_B and R_C Varied to obtain desired current levels D $_1$ MUST be fast recovery type, e.g.: 1N5825 USED ABOVE I $_B\approx 100$ mA MSD6100 USED BELOW I $_B\approx 100$ mA FOR PNP TEST CIRCUIT, REVERSE ALL POLARITIES

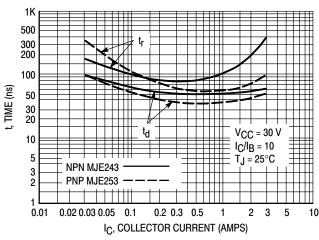


Figure 3. Turn-On Time

Figure 2. Switching Time Test Circuit

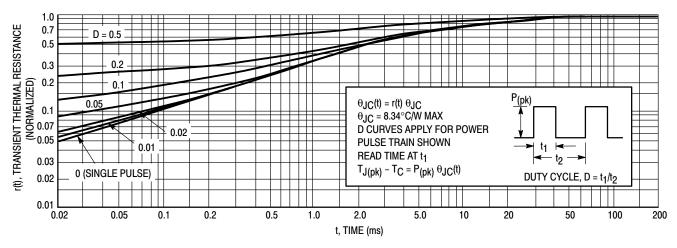


Figure 4. Thermal Response

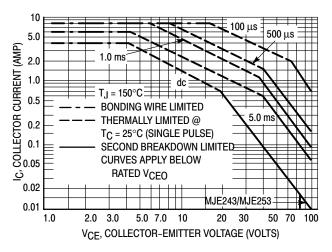
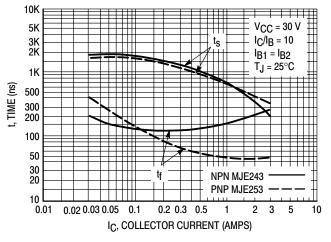


Figure 5. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on $T_{J(pk)} = 150^{\circ}C$; T_{C} is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ}C$. $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.





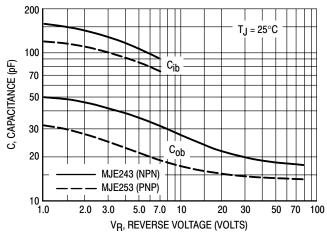


Figure 7. Capacitance

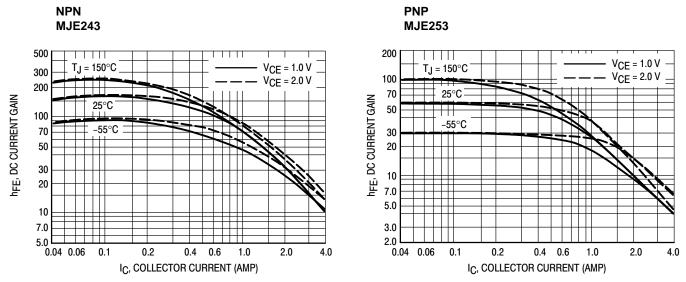


Figure 8. DC Current Gain

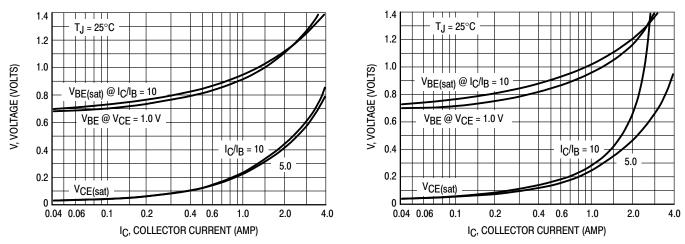


Figure 9. "On" Voltages

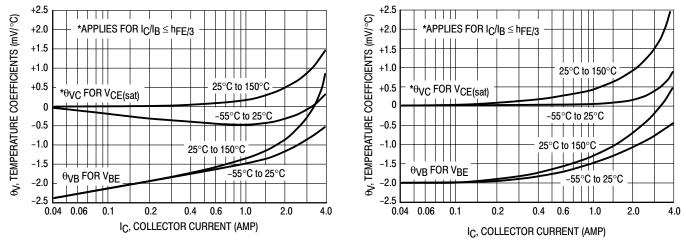
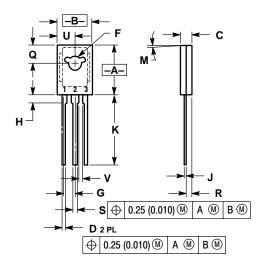


Figure 10. Temperature Coefficients

PACKAGE DIMENSIONS

TO-225AA **CASE 77-09 ISSUE W**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.425	0.435	10.80	11.04
В	0.295	0.305	7.50	7.74
С	0.095	0.105	2.42	2.66
D	0.020	0.026	0.51	0.66
F	0.115	0.130	2.93	3.30
G	0.094 BSC		2.39 BSC	
Н	0.050	0.095	1.27	2.41
J	0.015	0.025	0.39	0.63
K	0.575	0.655	14.61	16.63
M	5° TYP		5° TYP	
Q	0.148	0.158	3.76	4.01
R	0.045	0.065	1.15	1.65
S	0.025	0.035	0.64	0.88
U	0.145	0.155	3.69	3.93
٧	0.040		1.02	

STYLE 1:
PIN 1. EMITTER
2. COLLECTOR
3. BASE

Notes

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